

General Description

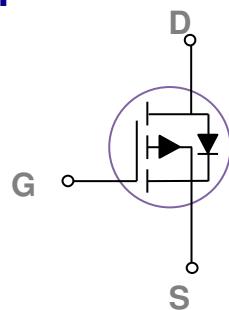
These P-Channel enhancement mode power field effect transistors are using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.

BVDSS	RDS(ON)	ID
-60V	9.2mΩ	-75A

Features

- -60V,-75A, RDS(ON) =9.2mΩ@VGS = -10V
- Fast switching
- Green Device Available
- Suit for -4.5V Gate Drive Applications

TO263 Pin Configuration



Absolute Maximum Ratings T_c=25°C unless otherwise noted

Symbol	Parameter	Rating	Units
V _{DS}	Drain-Source Voltage	-60	V
V _{GS}	Gate-Source Voltage	±20	V
I _D	Drain Current – Continuous (T _c =25°C)	-75	A
	Drain Current – Continuous (T _c =100°C)	-47.5	A
I _{DM}	Drain Current – Pulsed ¹	-300	A
EAS	Single Pulse Avalanche Energy ²	320	mJ
IAS	Single Pulse Avalanche Current ²	80	A
P _D	Power Dissipation (T _c =25°C)	183	W
	Power Dissipation – Derate above 25°C	1.47	W/°C
T _{STG}	Storage Temperature Range	-55 to 150	°C
T _J	Operating Junction Temperature Range	-55 to 150	°C

Thermal Characteristics

Symbol	Parameter	Typ.	Max.	Unit
R _{θJA}	Thermal Resistance Junction to ambient	---	62	°C/W
R _{θJC}	Thermal Resistance Junction to Case	---	0.68	°C/W

Electrical Characteristics ($T_J=25^\circ\text{C}$, unless otherwise noted)
Off Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}$, $I_D=-250\mu\text{A}$	-60	---	---	V
$\Delta \text{BV}_{\text{DSS}}/\Delta T_J$	BV_{DSS} Temperature Coefficient	Reference to 25°C , $I_D=1\text{mA}$	---	0.036	---	$\text{V}/^\circ\text{C}$
$I_{\text{DS}}^{\text{SS}}$	Drain-Source Leakage Current	$V_{\text{DS}}=-60\text{V}$, $V_{\text{GS}}=0\text{V}$, $T_J=25^\circ\text{C}$	---	---	-1	μA
		$V_{\text{DS}}=-48\text{V}$, $V_{\text{GS}}=0\text{V}$, $T_J=125^\circ\text{C}$	---	---	-10	μA
I_{GSS}	Gate-Source Leakage Current	$V_{\text{GS}}=\pm 20\text{V}$, $V_{\text{DS}}=0\text{V}$	---	---	± 100	nA

On Characteristics

$R_{\text{DS(ON)}}$	Static Drain-Source On-Resistance	$V_{\text{GS}}=-10\text{V}$, $I_D=-20\text{A}$	---	7.6	9.2	$\text{m}\Omega$
		$V_{\text{GS}}=-4.5\text{V}$, $I_D=-10\text{A}$	---	9.3	12	$\text{m}\Omega$
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{\text{GS}}=V_{\text{DS}}$, $I_D = -250\mu\text{A}$	-1.2	-1.6	-2.5	V
			---	-6.3	---	$\text{mV}/^\circ\text{C}$
g_{fs}	Forward Transconductance	$V_{\text{DS}}=-10\text{V}$, $I_D=-3\text{A}$	---	18	---	S

Dynamic and switching Characteristics

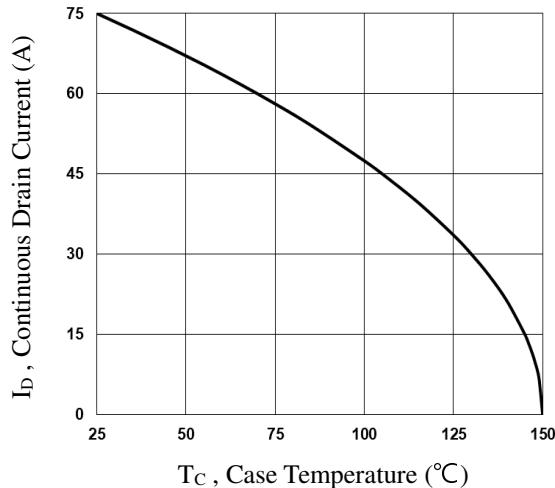
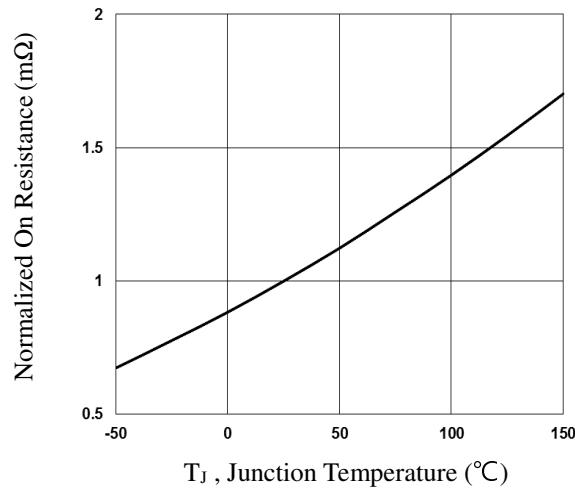
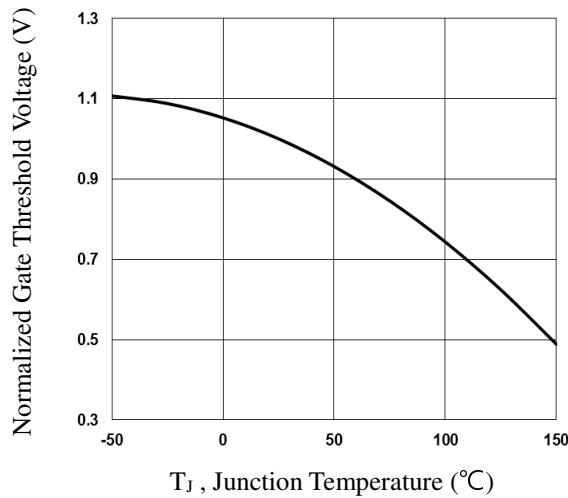
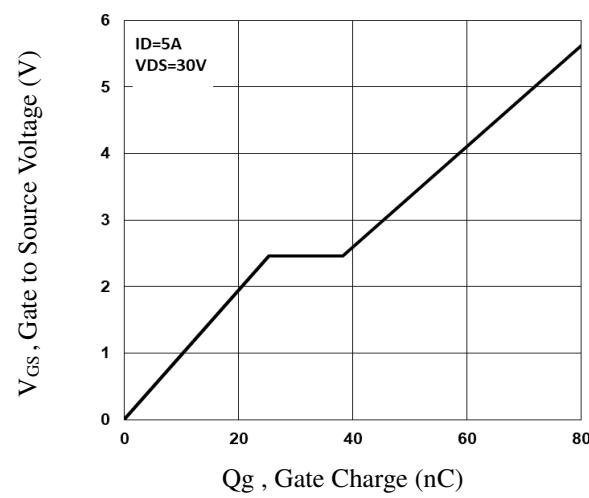
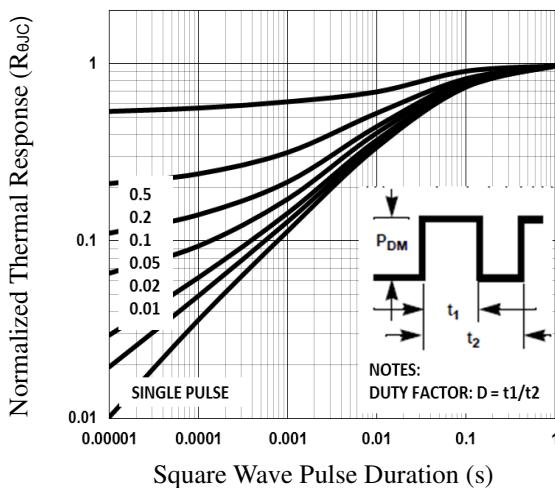
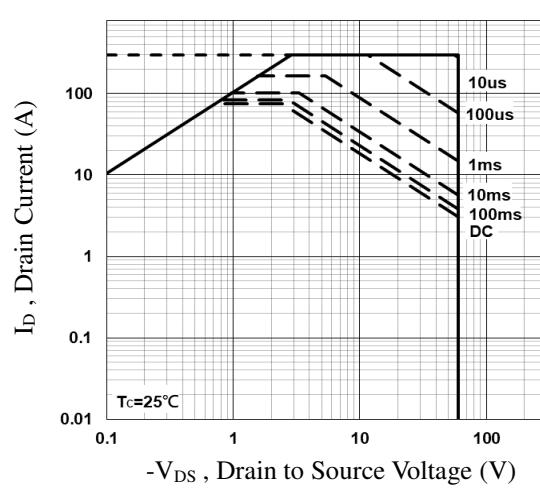
Q_g	Total Gate Charge ^{3,4}	$V_{\text{DS}}=-30\text{V}$, $V_{\text{GS}}=-10\text{V}$, $I_D=-5\text{A}$	---	138	210	nC
Q_{gs}	Gate-Source Charge ^{3,4}		---	25.4	38	
Q_{gd}	Gate-Drain Charge ^{3,4}		---	12.8	19	
$T_{\text{d(on)}}$	Turn-On Delay Time ^{3,4}	$V_{\text{DD}}=-48\text{V}$, $V_{\text{GS}}=-10\text{V}$, $R_G=6\Omega$ $I_D=-1\text{A}$	---	70	140	ns
T_r	Rise Time ^{3,4}		---	205	410	
$T_{\text{d(off)}}$	Turn-Off Delay Time ^{3,4}		---	402	804	
T_f	Fall Time ^{3,4}		---	197	394	
C_{iss}	Input Capacitance	$V_{\text{DS}}=-25\text{V}$, $V_{\text{GS}}=0\text{V}$, $F=1\text{MHz}$	---	8620	12930	pF
C_{oss}	Output Capacitance		---	486	730	
C_{rss}	Reverse Transfer Capacitance		---	288	430	

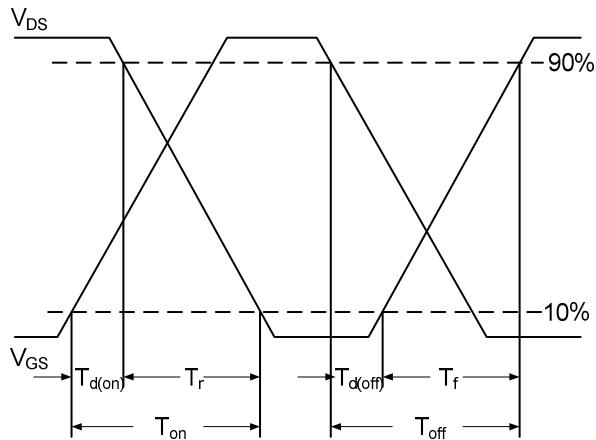
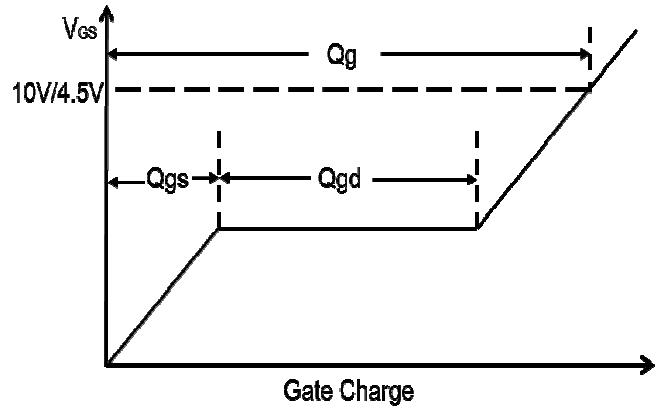
Drain-Source Diode Characteristics and Maximum Ratings

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
I_s	Continuous Source Current	$V_G=V_D=0\text{V}$, Force Current	---	---	-75	A
			---	---	-150	A
V_{SD}	Diode Forward Voltage	$V_{\text{GS}}=0\text{V}$, $I_s=1\text{A}$, $T_J=25^\circ\text{C}$	---	---	-1	V
			---	370	---	ns
Q_{rr}	Reverse Recovery Charge	$V_{\text{GS}}=10\text{V}$, $I_s=10\text{A}$, $dI/dt=100\text{A}/\mu\text{s}$	---	1740	---	nC

Note :

1. Repetitive Rating : Pulsed width limited by maximum junction temperature.
2. $V_{\text{DD}}=50\text{V}$, $V_{\text{GS}}=10\text{V}$, $L=0.1\text{mH}$, $I_{\text{AS}}=80\text{A}$, $R_G=25\Omega$, Starting $T_J=25^\circ\text{C}$.
3. The data tested by pulsed, pulse width $\leq 300\text{us}$, duty cycle $\leq 2\%$.
4. Essentially independent of operating temperature.


Fig.1 Continuous Drain Current vs. T_c

Fig.2 Normalized RDS(on) vs. T_j

Fig.3 Normalized Vth vs. T_j

Fig.4 Gate Charge Characteristics

Fig.5 Normalized Transient Impedance

Fig.6 Maximum Safe Operation Area


Fig.7 Switching Time Waveform

Fig.8 Gate Charge Waveform

TO263 PACKAGE INFORMATION

